



REQUIREMENTS

CONTACT RESISTANCE:30mΩmax.(INITIAL)  
 INSULATION RESISTANCE:100MΩmin.AT 500V DC.  
 WITHSTANDING VOLTAGE:500V AC FOR ONE MINUTE  
 SOLDERING HEAT TEST:260±5°C FOR 5±1 SECONDS  
 INSERTION FORCE:0.5-4.5KG  
 EXTRACTION FORCE:0.4-3.5 KG  
 LIFE TIME:5000 CYCLES min

NO	NAME	MATERIAL	FINISH	REMARK	Q'TY
1	HOUSING	P.B.T	BLACK		1
2	CONTACT	PHOS.BRONZE	GOLD-TIN PLATED	Ni:1~1.5u Gold:1~3u	8
3	SHIELD	COPPER ALLOY	TIN-LEAD PLATED	TIN:3~5u	1
4	BACK COVER	P.B.T	BLACK		1

尚益科技有限公司 JMSSCONN TECHNOLOGY CO., LED.					
PROJ		SCALE : F DO NOT SCALE DWG	MOLD NO 30020-08-02		
APP			MODEL	FILE NO	REV. X1
CHK	CCJ	90.07.24	UNIT	SHT 1 OF 1	SIZE A4
DGN	WU	90.07.24	MM		
DRW	SHIEH	90.07.24			